

DO-15 Plastic-Encapsulate Diodes

SB2150 THRU SB2200

Schottky Rectifier Diodes

Features

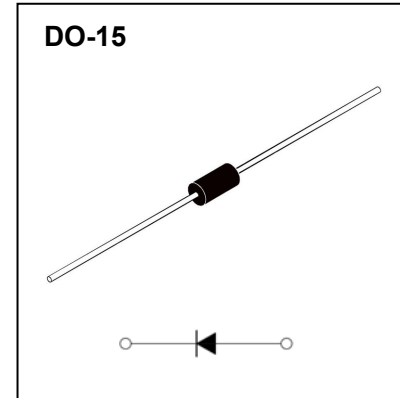
- $I_{F(AV)}$ 2A
- V_{RRM} 150V-200V
- High surge current capability
- Polarity: Color band denotes cathode

Applications

- Rectifier

Marking

- SB2150:SB2150
- SB2200:SB2200



Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Conditions	SB2	
				150	200
Repetitive Peak Reverse Voltage	V_{RRM}	V		150	200
Maximum RMS Voltage	V_{RMS}	V		105	140
Maximum DC blocking Voltage	V_{DC}	V		150	200
Average Forward Current	$I_{F(AV)}$	A	60Hz Half-sine wave, Resistance load, $T_L=100^{\circ}C$	2.0	
Surge(Non-repetitive)Forward Current	I_{FSM}	A	60Hz Half-sine wave, 1 cycle, $T_a=25^{\circ}C$	60	
Junction Temperature	T_J	$^{\circ}C$		-55 ~ +150	
Storage Temperature	T_{STG}	$^{\circ}C$		-55 ~ +150	

Electrical Characteristics ($T_a=25^{\circ}C$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition	SB2	
				150	200
Maximum Peak Forward Voltage	V_{FM}	V	$I_{FM}=2.0A$	0.85	0.95
Maximum Peak Reverse Current	I_{RRM1}	mA	$V_{RM}=V_{RRM}$	$T_a=25^{\circ}C$	0.2
	I_{RRM2}			$T_a=100^{\circ}C$	2.0
Typical Junction Capacitance	C_J	pF	Measured at 1MHz and applied reverse voltage of 4.0V D.C.	80	
Typical Thermal Resistance	$R_{\theta J-A}$	$^{\circ}C/W$	Between junction and ambient	50	
	$R_{\theta J-L}$		Between junction and lead	25	

Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

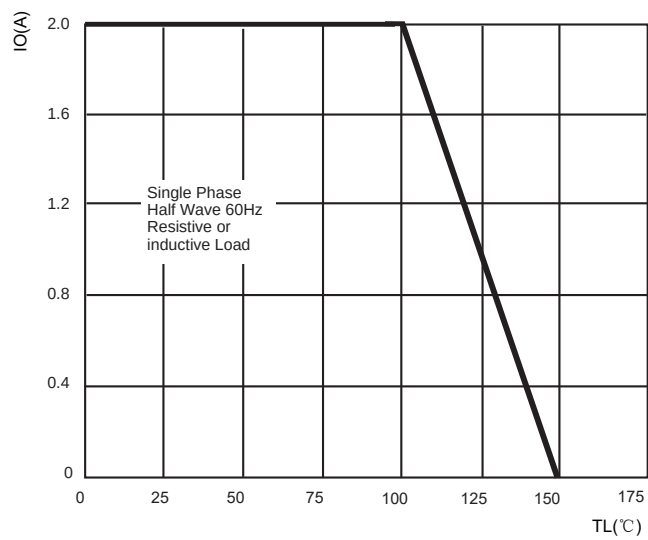


FIG.2: MAXIMUM NON-REPETITIVE FORWARD URGE CURRENT

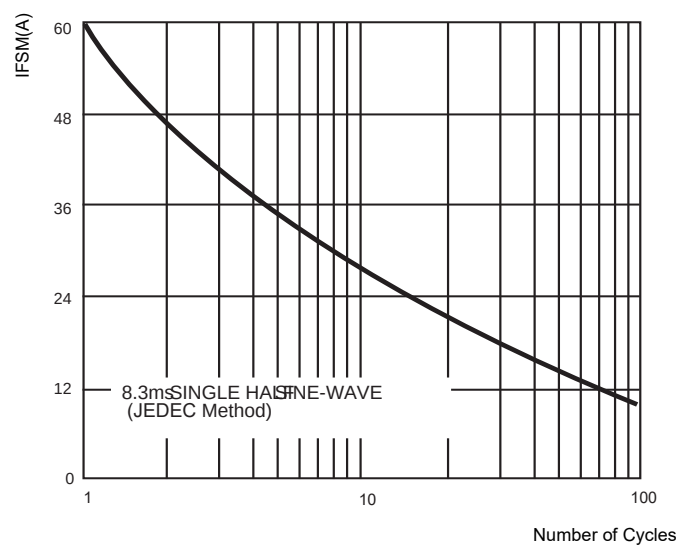


FIG.3: TYPICAL FORWARD CHARACTERISTICS

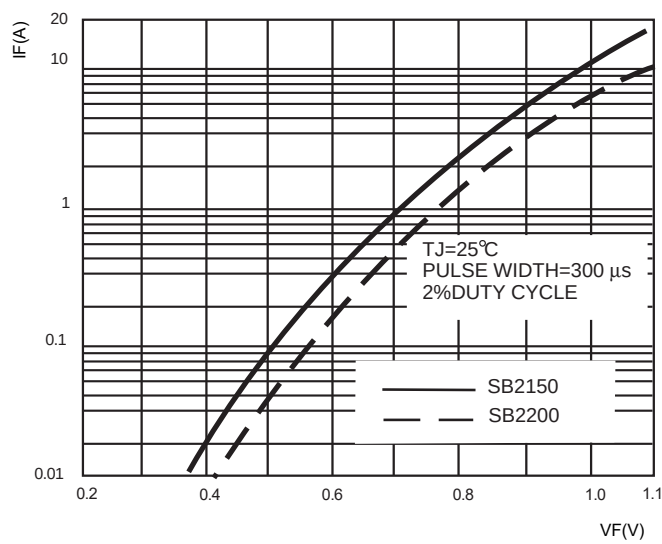
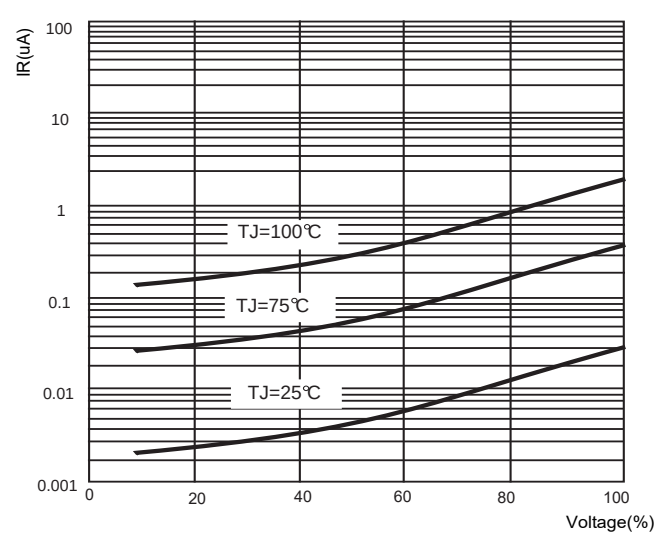
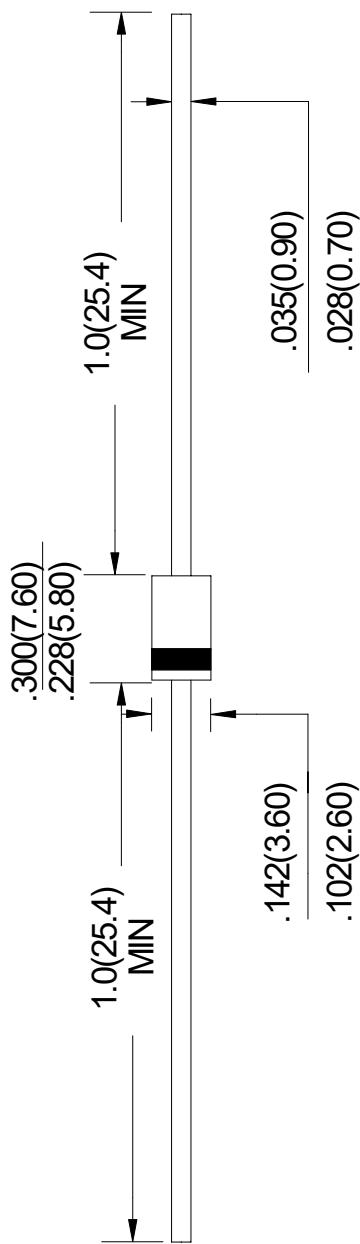


FIG.4: TYPICAL REVERSE CHARACTERISTICS





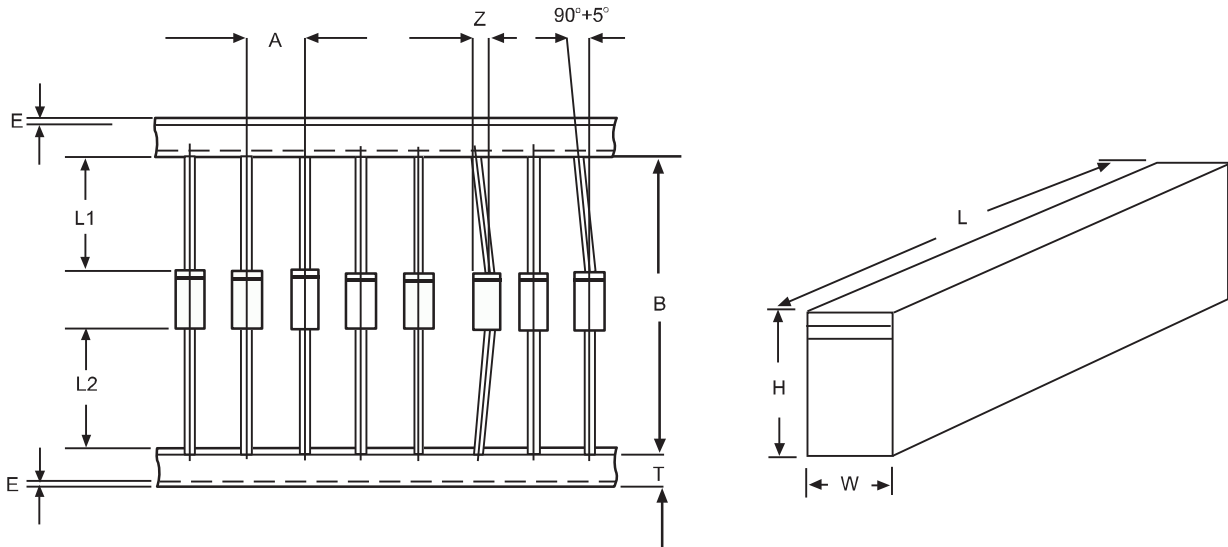
Unit: in inches (millimeters)

NOTICE
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Ammo Box Packaging Specifications For Axial Lead Rectifiers

Axial lead devices are packed in accordance with EIA standard RS-296-D and specifications given below

COMPONENT OUTLINE	COMPONENT PITCH A	INNER TAPE PITCH B	CUMULATIVE PITCH TOLERANCE
	±0.5mm(.020``)	+0.5mm(.020``)	
R-1	5.0mm	26.0mm	2.0mm/20pitch
R-1	5.0mm	52.4mm	2.0mm/10pitch
A-405	5.0mm	26.0mm	2.0mm/20pitch
A-405	5.0mm	52.4mm	2.0mm/10pitch
DO-34/DO-35	5.0mm	26.0mm	2.0mm/20pitch
DO-34/DO-35	5.0mm	52.4mm	2.0mm/10pitch
DO-41	5.0mm	26.0mm	2.0mm/20pitch
DO-41	5.0mm	52.4mm	2.0mm/10pitch
DO-15	5.0mm	52.4mm	2.0mm/10pitch
DO-27	10.0mm	52.4mm	2.0mm/10pitch
R-6	10.0mm	52.4mm	2.0mm/10pitch



ITEM	SYMBOL	SPECIFICATIONS(mm)	SPECIFICATIONS(inch)
Component alignment	Z	1.2max	0.048max
Tape width	T	6.0±0.4	0.236±0.016
Exposed adhesive	E	0.8max	0.032max
Body eccentricity	IL1-L2I	1.0max	0.040max
Box length	L	255.0±5.0	10.04±0.197
Box width	W	78.0±5.0	3.07±0.197
Box height	H	150.0±5.0	5.91±0.197

NOTE:Each component lead shall be sandwiched between tapes for A minimum of 3.2mm(0.126``)